502885118 07/09/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEUNG HUN YANG	05/22/2014
BYOUNG YUN KIM	05/22/2014
JUNG EUN KIM	05/22/2014
SEUNG UK YEU	05/22/2014
JUNG SU HAN	05/22/2014

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14371372	

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DATE SIGNED:	07/09/2014

Total Attachments: 2

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502885118 PATENT REEL: 033274 FRAME: 0568

Assignment of Application

WHEREAS, I (W	YANG, Seung Hun; KIM, Byoung Yun; KIM, Jung Eun; YEU, Seung Uk; HAN, Jung Su		
		, respectively,	
have invented certain no	ew and useful improvements in:		
LATEX COMPOS	SITION FOR DIP MOLDING AND DIP-MO PRODUCED THEREFROM	LDED ARTICLE	
for which an application	n for Letters Patent was executed on		
(Application No.	, Filed), and	
WHEREAS, LG	CHEM, LTD.		
,	as "ASSIGNEE") having a place of business a ongdeungpo-gu, Scoul 150-721, Republic of l		

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.



Docket No.:

The undersigned hereby grant(s) the firm of McKenna Long & Aldridge LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: May 22th 2014

(Signature of Inventor)
YANG, Seung I

Date: May 22th 2014

(Signature of Inventor)
(Signature of Inventor) YANG, Seung Hun

KIM, Byoung Yun

Date: May / 2244 / 2014

Date: May / 22th /2014

Date: May / 22th /2014 (Signature of Inventor)
YEU Seung Uk

(Signature of Inventor) HAN, Jung Su

> McKenna Long & Aldridge LLP Attorneys At Law

> > 1900 K Street, N.W. Washington, D.C. 20006